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# FSA2866 Dual-Host / Dual-SIM Card Crosspoint Analog Switch

### **Features**

Switch Type	2x2 Crosspoint Switch
Input Type	Data
Input Signal Range	0 to V <sub>CC</sub>
V <sub>CC</sub>	1.65V to 4.30V
Ron	Data 2Ω (Typical) VSIM 2Ω (Typical)
R <sub>FLAT</sub>	0.6Ω (Typical)
FSD	IEC 61000-4-2 System
LOD	Air 15kV, Contact 8kV
Con	28pF (Typical)
C <sub>OFF</sub>	12pF (Typical)
	20-Lead UMLP, 3 x 3 x
Package	0.55mm, 0.40mm Pitch
	with Exposed DAP
Ordering Information	FSA2866UMX

### Description

The FSA2866 is a dual-host, dual-SIM card analog switch designed specifically for cell phones that support two specific carrier services (for example, CDMA and GSM/3G).

### **Related Resources**

- For samples and questions, please contact: Analog.Switch@fairchildsemi.com.
- FSA2866 Evaluation Board

### **Applications**

- MP3 Portable Media Players
- Cellular Phones, Smart Phones

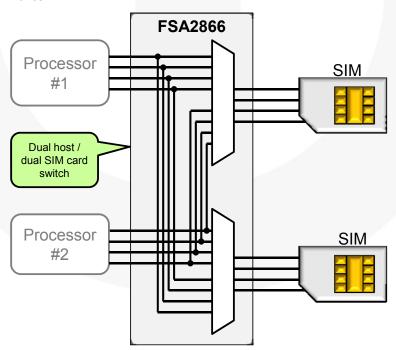
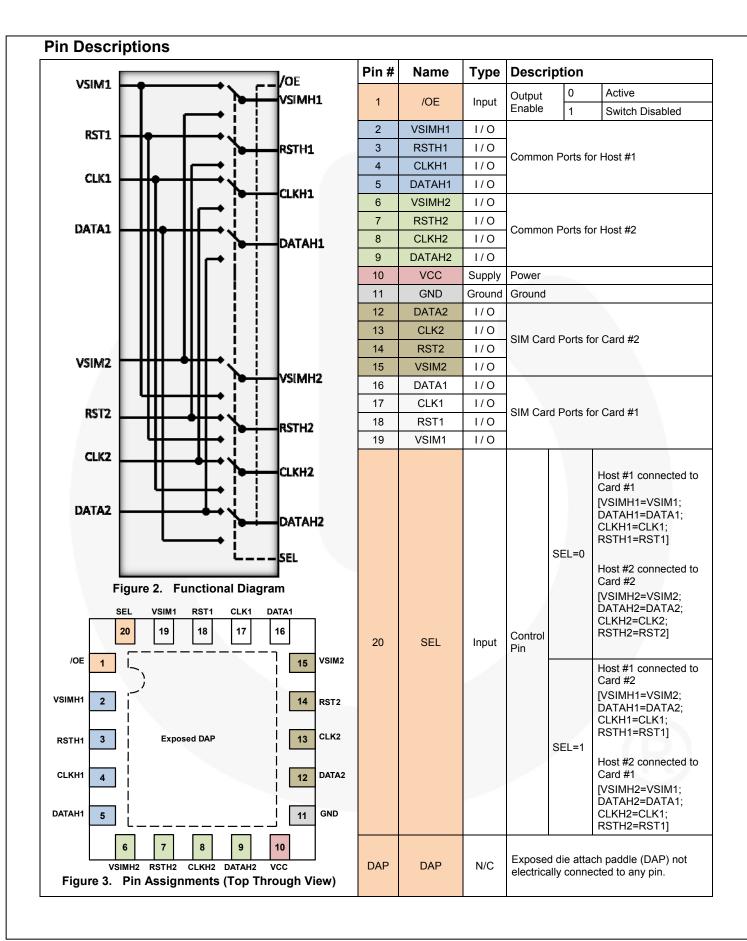


Figure 1. Typical Mobile Phone Application



### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Unit
V <sub>CC</sub>	Supply Voltage		-0.50	+5.5	V
V <sub>CNTRL</sub>	DC Input Voltage (SEL,/OE)		-0.5	V <sub>CC</sub>	V
V <sub>SW</sub>	DC Switch I/O Voltage - DATAHn, CLKHn, CLKn, F	RSTHn, RSTn	-0.5	V <sub>CC</sub> + 0.3	V
I <sub>IK</sub>	DC Input Diode Current		-50		mA
I <sub>SIM</sub>	DC Output Current – VSIMHn, VSIMn			100	mA
lout	DC Output Current - DATAHn, CLKHn, CLKn, RS7	THn, RSTn		35	mA
T <sub>STG</sub>	Storage Temperature		-65	+150	°C
		All Pins	8		
	Human Body Model, JEDEC: JESD22-A114	I/O to GND, Card Side Pins	16		
ECD		Power to GND	9		147
ESD	Charged Device Model, JEDEC: JESD22-C101		2		kV
	IFC 61000 4.2 System Lovel	Contact	8		
	IEC 61000-4-2 System-Level	Air Gap	15		

### **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding these ratings or designing to Absolute Maximum Ratings.

Symbol I	Symbol Parameter			Max.	Unit
V <sub>CC</sub>	Supply Voltage			4.3	V
V <sub>CNTRL</sub>	Control Input Voltage (SEL, /OE)	0		Vcc	V
V <sub>SW</sub>	Switch I/O Voltage - DATAHn, CLKHn, CLKn, RSTHn, RSTn	0		V <sub>CC</sub>	V
I <sub>SIM</sub>	DC Output Current – VSIMHn, VSIMn			30	mA
I <sub>OUT</sub>	I <sub>OUT</sub> DC Output Current – DATAHn, CLKHn, CLKn, RSTHn, RSTn			10	mA
T <sub>A</sub>	Operating Temperature	-40		+85	°C

### **DC Electrical Characteristics**

 $T_A$ =25°C and  $V_{CC}$ =3.0V unless otherwise noted.

Symbol Parameter		Conditions	V <sub>cc</sub> (V)	T <sub>A</sub> =- 40°C to +85°C		Unit		
				Min.	Ту р.	Max.		
VıK	Clamp Diode Voltage	I <sub>IN</sub> =-18mA	2.7			-1.2	V	
			1.65 to 2.30	1.1				
V <sub>IH</sub>	Input Voltage High		2.7 to 3.6	1.3			V	
			4.3	1.7				
			1.65 to 2.30			0.4		
$V_{IL}$	Input Voltage Low		2.7 to 3.6			0.5	V	
			4.3			0.7		
I <sub>IN</sub>	Control Input Leakage (SEL,/OE)	V <sub>SW</sub> =0 to V <sub>CC</sub>	4.3	-1		1	μA	
I <sub>NO(OFF)</sub>	Off Leakage Current of Ports RSTn, DATAn, CLKn, VSIMn	VSIMHn=DATAHn=CLKHn=RSTHn=0.3 V, V <sub>CC</sub> -0.3V; RSTn, CLKn, DATAn, or VSIMn=V <sub>CC</sub> -0.3V, 0.3V, or Floating	4.3	-100		100	nA	
I <sub>A(ON)</sub>	On Leakage Current of Common Ports – RSTHn, DATAHn, CLKHn, VSIMHn	Common=0.3V, V <sub>CC</sub> -0.3V; VSIMHn=DATAHn=CLKHn=RSTHn= V <sub>CC</sub> -0.3V, 0.3V, or Floating	4.3	-100		100	nA	
I <sub>OFF</sub>	Power-Off Leakage Current	VSIMHn or DATAHn or CLKHn or RSTHn $V_{IN}$ =0V to 4.3V, $V_{CC}$ =0V	0	-2		2	μΑ	
l <sub>OZ</sub>	Off-State Leakage	VSIMHn or DATAHn or CLKHn or RSTHn $V_{IN}$ =0.3V to 4.3V, $I$ OE= $I$ CC	4.3	-5		5	μΑ	
R <sub>ON_DATA</sub>	Switch On Resistance for Data Paths	I <sub>ON</sub> =-20mA; /OE=0V; SEL=V <sub>CC</sub> or 0V; RSTn, CLKn, DATAn, or VSIMn=0 or 2.7V	2.7		2.0	3.5	Ω	
R <sub>ON_VSIM</sub>	Switch On Resistance for VSIM Paths	I <sub>ON</sub> =- 50mA; /OE=0V; SEL=V <sub>CC</sub> or 0V; RSTn, CLKn, DATAn, or VSIMn=0 or 2.7V	2.7		2.0	3.5	Ω	
$\Delta R_{ON\_DATA}$	On Resistance Matching Between Data Channels	I <sub>ON</sub> =-20mA; /OE=0V; SEL=V <sub>CC</sub> or 0V; RSTn, CLKn, or DATAn=0V	2.7		0.10	0.25	Ω	
R <sub>ON_FLAT</sub>	On Resistance Flatness Data Path Signals	$I_{\text{ON}}$ =-20mA, /OE=0V,SEL=V <sub>CC</sub> or 0V, RSTn, CLKn or DATAn=0 to V <sub>CC</sub>	2.7		0.6	0.8	Ω	
Icc	Quiescent Supply Current	V <sub>IN</sub> =0 or V <sub>CC</sub> , I <sub>OUT</sub> =0	4.3			1	μA	
I <sub>CCT</sub>	Increase in I <sub>CC</sub> Current Per Control Voltage and V <sub>CC</sub>	V <sub>IN</sub> =1.65V, V <sub>CC</sub> =4.3V	4.3		7	9.5	μA	

### Notes:

- 1. Guaranteed by characterization; not production tested.
- 2. On resistance is determined by the voltage drop between the D+/D- and D+/R, D-/L pins at the indicated current through the switch.
- 3.  $\Delta R_{ON} = R_{ON\_max} R_{ON\_min}$  measured at identical  $V_{CC}$ , temperature, and voltage.

### **AC Electrical Characteristics**

 $T_A$ =25°C and  $V_{CC}$ =3.0V unless otherwise noted.

Cymah al	Donomotor	Conditions V <sub>cc</sub> (V)	Conditions Y (V) T <sub>A</sub> =- 40°C to		+85°C	11:4:4	
Symbol	Parameter	Conditions	V <sub>cc</sub> (V)	Min.	Ту р.	Max.	Unit
4	Turn On Time /OE to Output	$R_L=50\Omega$ , $C_L=30pF$ , $V_{SW}=0.8V$	2.8 to 4.3		55	75	no
t <sub>ON</sub>	Turn-On Time, /OE to Output	Figure 4	1.8			110	ns
4	Turn-Off Time, /OE to Output	$R_L=50\Omega$ , $C_L=30pF$ , $V_{SW}=0.8V$	2.8 to 4.3		24	75	ns
t <sub>OFF</sub>	Turn-Oil Time, /OE to Output	Figure 4	1.8			110	115
t <sub>BBM</sub>	Break-Before-Make Time	$R_L$ =50 $\Omega$ , $C_L$ =30pF, $V_{SW}$ =0.8V Figure 5		2	35		ns
O <sub>IRR</sub>	Off Isolation	$R_L$ =50 $\Omega$ , f=100KHz, /OE=V <sub>CC</sub> , V <sub>SW</sub> =13dBm (3V <sub>pp</sub> ) Figure 6	1.8 to 4.3		90		dB
X <sub>TALK</sub>	Crosstalk	$R_L$ =50 $\Omega$ , f=100KHz, V <sub>SW</sub> =13dBm (3V <sub>pp</sub> ) Figure 6	1.8 to 4.3		85		dB
		$R_L$ =50 $\Omega$ , $C_L$ =0pF, Figure 8			210		
BW	-3db Bandwidth	$R_L$ =50 $\Omega$ , $C_L$ =5pF, Figure 8	3.0		198		MHz
DVV	-Sub Bariuwidiri	$R_L$ =50 $\Omega$ , $C_L$ =30pF, Figure 8	3.0		120		IVII IZ
		$R_L$ =50 $\Omega$ , $C_L$ =50pF, Figure 8			78		

### Note:

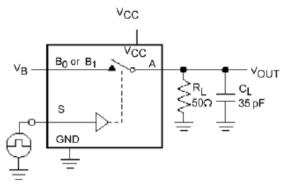
4. Guaranteed by characterization; not production tested.

### Capacitance

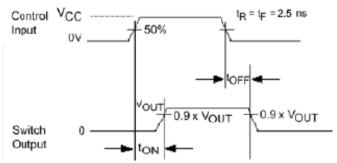
T<sub>A</sub>=25°C unless otherwise noted.

Symbol Parameter		Conditions		T <sub>A</sub> =- 40°C to +85°C		
Syllibol	Parameter	Conditions	Min. T	y p.	Max.	Unit
C <sub>IN</sub>	Control Pin Input Capacitance	V <sub>CC</sub> =0V, f=1MHz		2	7	pF
C <sub>ON</sub>	On Capacitance	V <sub>CC</sub> =3.3V, /OE=0V, f=1MHz, Figure 7		28		pF
C <sub>OFF</sub>	Off Capacitance	V <sub>CC</sub> and /OE=3.3V, f=1MHz, Figure 7		12		pF

### **AC Loadings and Waveforms**

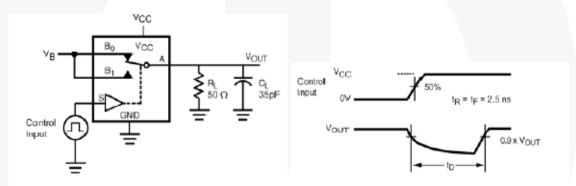


C<sub>L</sub> includes Fixture and Stray Capacitance



Logic Input Waveforms Inverted for Switches that have the Opposite Logic Sense

Figure 4. Turn-On / Turn-Off Timing



C<sub>L</sub> Includes Fixture and Stray Capacitance

Figure 5. Break-Before-Make Timing

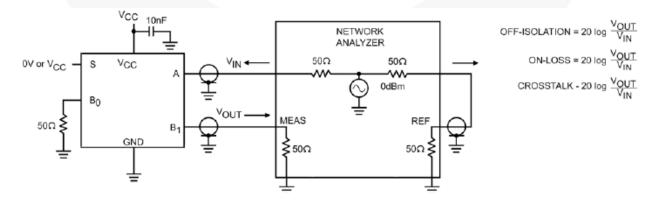


Figure 6. Off Isolation and Crosstalk

### AC Loadings and Waveforms (Continued)

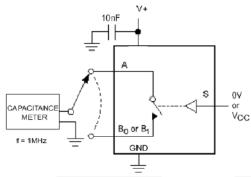


Figure 7. On / Off Capacitance Measurement Setup

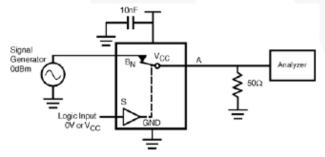
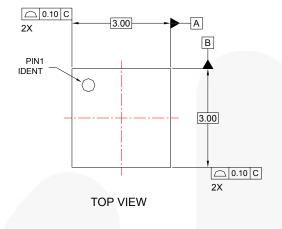
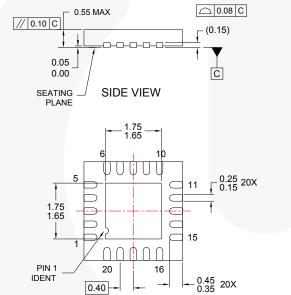
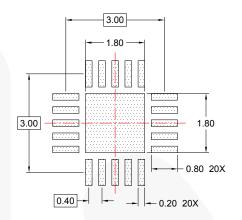


Figure 8. Bandwidth

### **Physical Dimensions**







### RECOMMENDED LAND PATTERN

### NOTES:

- A. PACKAGE CONFORMS TO JEDEC MO-248 VARIATION UEEE.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
- D. LAND PATTERN RECOMMENDATION IS FROM PCB MATRIX CALCULATOR V2009.
- E. DRAWING FILENAME: MKT-UMLP20Brev1.

**BOTTOM VIEW** 

Figure 9. 20-Pin Ultrathin Molded Leadless Package (UMLP)

0.10(M) C A B 0.05(M) C

Order Number	Operating Temperature Range	Package Description	Packing Method
FSA2866UMX	-40 to 85°C	20-Lead Ultrathin Molded Leadless Package (UMLP)	Tape & Reel

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